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STFH18N60M2

N-channel 600 V, 0.255 Ω typ., 13 A MDmesh[™] M2 Power MOSFET in a TO-220FP wide creepage package

Datasheet - production data

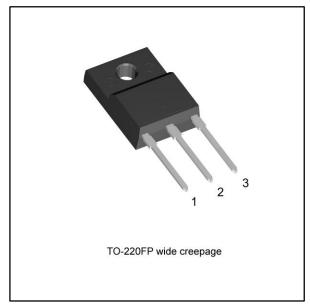
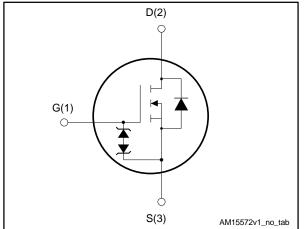


Figure 1: Internal schematic diagram



Features

Order code	V _{DS} @ T _{Jmax}	R _{DS(on)} max	ID
STFH18N60M2	650 V	0.28 Ω	13 A

- Extremely low gate charge
- Excellent output capacitance (Coss) profile
- 100% avalanche tested
- Zener-protected
- Wide creepage distance of 4.25 mm between the pins

Applications

- Switching applications
- LLC converters, resonant converters

Description

This device is an N-channel Power MOSFET developed using MDmesh[™] M2 technology. Thanks to its strip layout and an improved vertical structure, the device exhibits low on-resistance and optimized switching characteristics, rendering it suitable for the most demanding high efficiency converters.

The TO-220FP wide creepage package provides increased surface insulation for Power MOSFETs to prevent failure due to arcing, which can occur in polluted environments.

Table 1: Device summary

Order code	Marking	Package	Packing
STFH18N60M2	18N60M2	TO-220FP wide creepage	Tube

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This is information on a product in full production.

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vgs	Gate-source voltage	± 25	V
ID	Drain current (continuous) at $T_C = 25 \ ^\circ C$	13 ⁽¹⁾	А
lo	Drain current (continuous) at Tc = 100 °C	8 (1)	А
I _{DM} ⁽²⁾	Drain current (pulsed)	52 ⁽¹⁾	А
P _{TOT}	Total dissipation at $T_C = 25 \ ^{\circ}C$	25	W
dv/dt (3)	Peak diode recovery voltage slope	15	V/ns
dv/dt (4)	MOSFET dv/dt ruggedness	50	V/ns
V _{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat sink (t = 1 s; TC = 25 °C)	2500	V
T _{stg}	Storage temperature range	55 to 150	°C
Tj	Operating junction temperature range	- 55 to 150	C

Notes:

⁽¹⁾Limited by maximum junction temperature.

⁽²⁾Pulse width limited by safe operating area.

 $^{(3)}I_{SD} \le$ 13 A, di/dt \le 400 A/µs; V_DSpeak < V(BR)DSS, V_DD = 400 V. $^{(4)}V_{DS} \le$ 480 V.

Table 3: Thermal data

Symbol	bol Parameter		Unit
R _{thj-case}	Thermal resistance junction-case max	5	°C/W
R _{thj-amb}	Thermal resistance junction-ambient max	62.5	°C/W

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or not repetitive (pulse width limited by T_{jmax})	3	А
Eas	Single pulse avalanche energy (starting $T_j=25 \text{ °C}$, $I_D=I_{AR}$; $V_{DD}=50 \text{ V}$)	135	mJ



2 **Electrical characteristics**

(T_c = 25 °C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0 V, I_D = 1 mA$	600			V
I _{DSS} Zero gate voltage drain current		$V_{GS} = 0, V_{DS} = 600 V$			1	μA
		$V_{GS} = 0 V$, $V_{DS} = 600 V$, Tc=125 °C ⁽¹⁾			100	μA
lgss	Gate-body leakage current	$V_{DS} = 0, V_{GS} = \pm 25 V$			±10	μA
V _{GS(th)}	Gate threshold voltage	V _{DS} = V _{GS} , I _D = 250 µA	2	3	4	V
R _{DS(on)}	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 6.5 \text{ A}$		0.255	0.28	Ω

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Notes:

⁽¹⁾Defined by design, not subject to production test.

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	791	-	pF
Coss	Output capacitance	$V_{DS} = 100 V, f = 1 MHz,$	-	40	-	pF
Crss	Reverse transfer capacitance	$V_{GS} = 0 V$	-	5.6	-	pF
Coss eq. ⁽¹⁾	Equivalent output capacitance	V_{DS} = 0 to 480 V, V_{GS} = 0 V	-	164.5	-	pF
Rg	Intrinsic gate resistance	f = 1 MHz, I _D =0 A	-	5.6	-	Ω
Qg	Total gate charge	$V_{DD} = 480 \text{ V}, \text{ I}_{D} = 13 \text{ A},$	-	21.5	-	nC
Qgs	Gate-source charge	V _{GS} = 10 V	-	3.2	-	nC
Q _{gd}	Gate-drain charge	(see Figure 15: "Test circuit for gate charge behavior")	-	11.3	-	nC

Table 6: Dynamic

Notes:

⁽¹⁾Coss eq. is defined as a constant equivalent capacitance giving the same charging time as Coss when VDSinCreases from 0 to 80% VDSS



Electrical characteristics

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Table 7: Switching times							
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
t _{d(on)}	Turn-on delay time	$V_{DD} = 300 \text{ V}, \text{ I}_{D} = 6.5 \text{ A},$	-	12	-	ns	
tr	Rise time	R _G = 4.7 Ω, V _{GS} = 10 V (see Figure 14: "Test circuit for resistive load switching times" and Figure 19: "Switching time waveform")	-	9	-	ns	
t _{d(off)}	Turn-off delay time		-	47	-	ns	
t _f	Fall time		-	10.6	-	ns	

	Table	8:	Source	drain	diode
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Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD} ⁽¹⁾	Source-drain current		-		13	A
I _{SDM} ⁽¹⁾⁽²⁾	Source-drain current (pulsed)		-		52	A
V _{SD} ⁽³⁾	Forward on voltage	$I_{SD} = 13 \text{ A}, V_{GS} = 0 \text{ V}$	-		1.6	V
trr	Reverse recovery time	I _{SD} = 13 A, di/dt = 100 A/µs	-	305		ns
Qrr	Reverse recovery charge	V _{DD} = 60 V (see Figure 16: "Test circuit for inductive load switching and diode recovery times")	-	3.3		μC
I _{RRM}	Reverse recovery current		-	22		A
trr	Reverse recovery time	$I_{SD} = 13 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$ $V_{DD} = 60 \text{ V}, \text{ T}_{\text{j}} = 150 ^{\circ}\text{C}$ (see Figure 16: "Test circuit for inductive load switching and diode recovery times")	-	417		ns
Qrr	Reverse recovery charge		-	4.6		μC
I _{RRM}	Reverse recovery current		-	22		А

Notes:

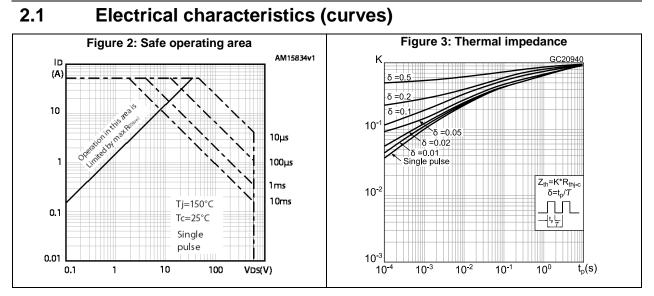
 $^{(1)}\mbox{The}$ value is rated according to $R_{thj\mbox{-}case}$ and limited by package.

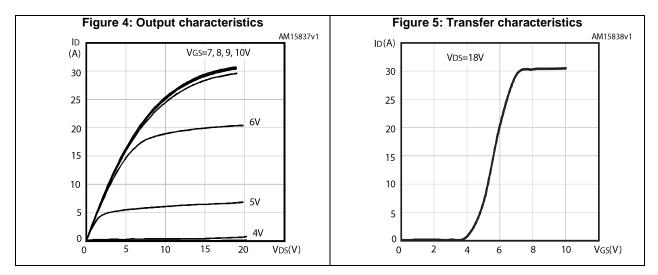
⁽²⁾Pulse width limited by safe operating area.

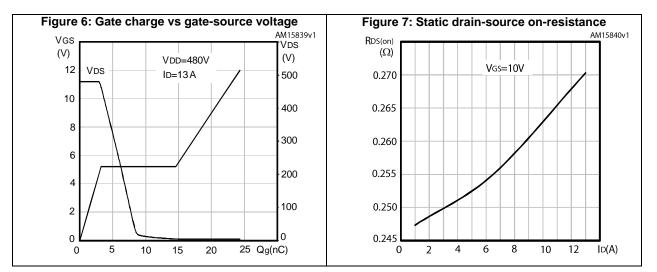
 $^{(3)}\text{Pulsed:}$ pulse duration = 300 µs, duty cycle 1.5%.











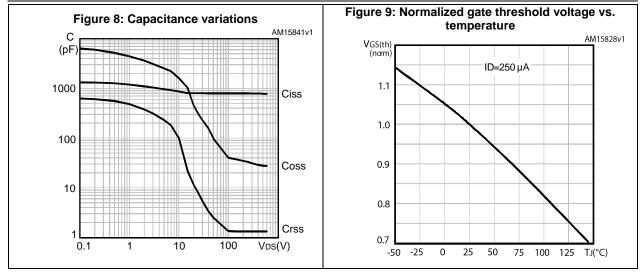
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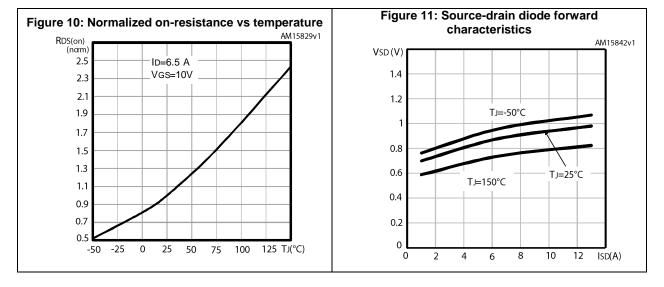


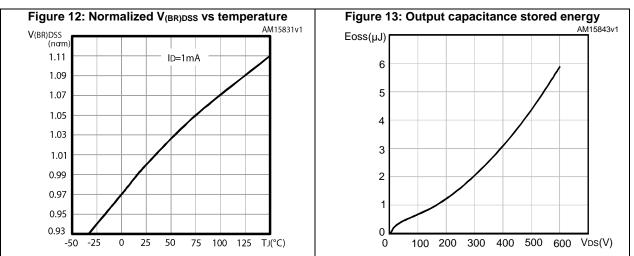
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Electrical characteristics

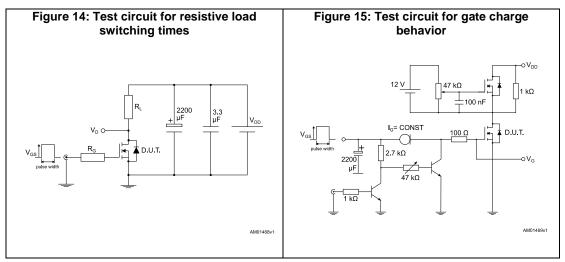


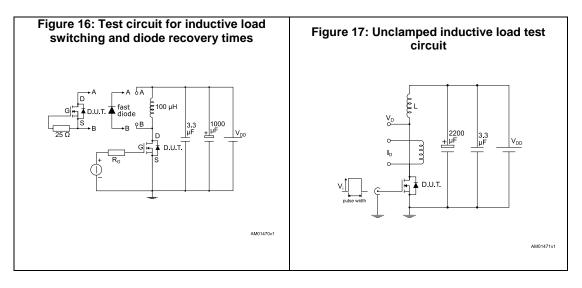


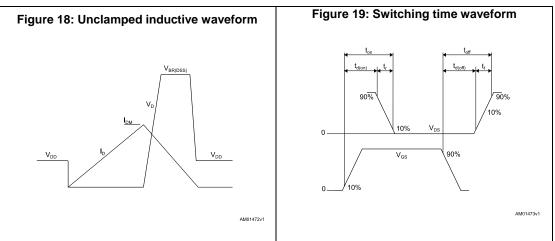


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3 Test circuits









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4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

4.1 TO-220FP wide creepage package information

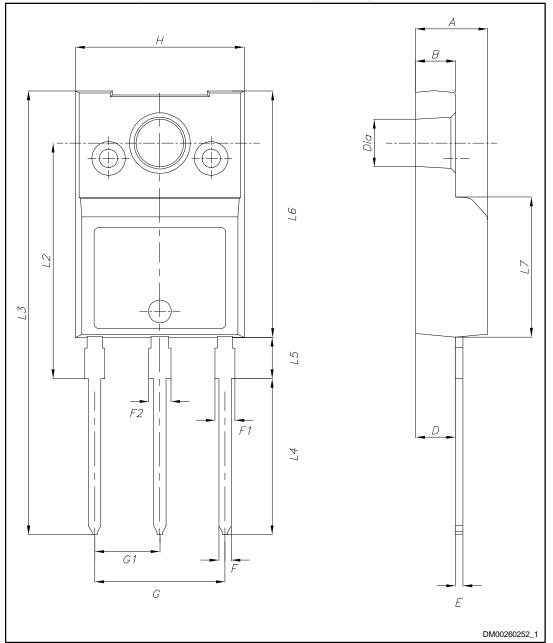


Figure 20: TO-220FP wide creepage package outline

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Package information

STFH18N60M2

nformation	rmation STFH18N60					
Tal	ole 9: TO-220FP wide cree	page package mechanica	al data			
Dim		mm				
Dim.	Min.	Тур.	Max.			
A	4.60	4.70	4.80			
В	2.50	2.60	2.70			
D	2.49	2.59	2.69			
E	0.46		0.59			
F	0.76		0.89			
F1	0.96		1.25			
F2	1.11		1.40			
G	8.40	8.50	8.60			
G1	4.15	4.25	4.35			
Н	10.90	11.00	11.10			
L2	15.25	15.40	15.55			
L3	28.70	29.00	29.30			
L4	10.00	10.20	10.40			
L5	2.55	2.70	2.85			
L6	16.00	16.10	16.20			
L7	9.05	9.15	9.25			
Dia	3.00	3.10	3.20			
Dia	0.00	0.10	0.20			



5 Revision history

Table 10: Document revision history

Date	Revision	Changes
08-Jun-2016	1	First release.
16-Jun-2016	2	Document status promoted from preliminary data to production data. Minor text changes.



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